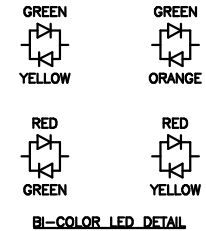


SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



1. MATERIAL:

HOUSING: PBT, BLACK, UL94V-0
 CONTACTS: 0.35[0.014] THICK PHOSPHOR BRONZE PLATED WITH
 100µ" MINIMUM THICK TIN IN SOLDER AREA.
 15µ" MINIMUM GOLD IN LOCALIZED PLATE AREA.
 ENTIRE CONTACTS PLATED WITH 30µ" MINIMUM THICK NICKEL.
 SHIELDED: 0.25[0.0098] THICK COPPER ZINC ALLOY PLATED WITH
 30µ" MINIMUM THICK NICKEL.

2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.

3. PART NUMBER: HRJM15-S1488-X-N-F1

REFER TO LED OPTIONS TABLE FOR ORDERING CODES

		UNIT		SCALE		SHEET	
		mm[inch]		1 of 1		TITLE:	
		DRAWN BY		APPROVED BY		RJ45, MODULAR JACK, 1X4, W/LED, 8P, 8C, SHIELDED, THRU-HOLE	
		董正一		謝瑞清			
		2002.02.01		2002.02.01			
		GENERAL TOLERANCE		ANGLE±		DRAW NO. :	
B0		NEW RELEASE		2005.12.25		HRJM15-S1488-X-N-F1	
REV.		DESCRIPTION		DATE		REV. B0	